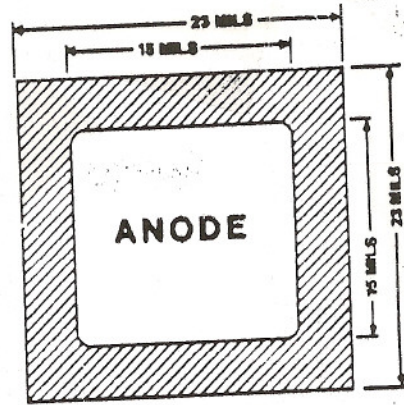




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Chip back potential is the level which bulk silicon is maintained by on-chip connection, or it is the level to which the chip back must be connected when specifically stated below. If no potential is given the chip back should be isolated.



Backside is Cathode

FIGURE 1

Topside Metal:

Backside:

Backside Potential:

Mask Ref:

Bond Pads (Mils):

APPROVED BY:

MFG: CDI

DIE SIZE (Mils): 23 X 23

THICKNESS:

DATE: 3/17/00

P/N: CZ-1114

DG 10.1.2

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